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# **Enhanced Light Extraction LED with a Tunnel Junction Contact Wafer Bonded to a Conductive Oxide**

Tech ID: 25741 / UC Case 2016-324-0

#### **BACKGROUND**

The development of light emitting devices (LEDs) with optimized materials is essential to increase the overall efficiency of the myriad commercial applications of the LED. Wafer bonding permits extension of the design parameters of these devices by allowing the formation of heterojunctions that are not possible through conventional deposition schemes. Bonding to transparent conductive materials leads to higher efficiency due to enhanced light extraction.

## **DESCRIPTION**

Researchers at the University of California, Santa Barbara have developed a method for bonding transparent conductive oxides on III-nitride materials using wafer bonding techniques. Light emitting devices (LEDs) can be processed using this technique which yields higher efficiency devices than traditional methods and allows for greater design options for fabricating devices such as fully transparent tunnel junction-based III-nitride-based LEDs.

## **ADVANTAGES**

- ► Increased light extraction efficiency
- ► Greater design options for fabricating devices

# **APPLICATIONS**

- ► Fully transparent tunnel junction-based LEDs
- ▶ LEDs

## **PATENT STATUS**

Country	Туре	Number	Dated	Case
United States Of America	Issued Patent	11,411,137	08/09/2022	2016-324

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#### **INVENTORS**

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## OTHER INFORMATION

### **KEYWORDS**

LED, tunnel junction, wafer bonded, conductive oxide, III-nitride, indfeat, indenergy

## **CATEGORIZED AS**

- **▶** Energy
  - Lighting
  - Other
- **►** Engineering
  - ▶ Engineering
- Semiconductors
  - ▶ Design and Fabrication

**RELATED CASES** 

2016-324-0

## **RELATED TECHNOLOGIES**

▶ III-Nitride Tunnel Junction LED with High Wall Plug Efficiency

## ADDITIONAL TECHNOLOGIES BY THESE INVENTORS

- ▶ Vertical Cavity Surface-Emitting Lasers with Continuous Wave Operation
- ▶ Eliminating Misfit Dislocations with In-Situ Compliant Substrate Formation
- ▶ Improved Reliability & Enhanced Performance of III-Nitride Tunnel Junction Optoelectronic Devices
- ► (In,Ga,AI)N Optoelectronic Devices with Thicker Active Layers for Improved Performance
- ► Thermally Stable, Laser-Driven White Lighting Device
- ► III-Nitride Tunnel Junction LED with High Wall Plug Efficiency
- ► A Method To Lift-Off Nitride Materials With Electrochemical Etch
- ► High-Intensity Solid State White Laser Diode
- ▶ Nitride Based Ultraviolet LED with an Ultraviolet Transparent Contact

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